



HAL
open science

A Mixed Surface Volume Integral Formulation for the Modeling of High Frequency Coreless Inductors

Z. de Greve, Jonathan Siau, Gérard Meunier, Jean-Michel Guichon, Olivier Chadebec

► **To cite this version:**

Z. de Greve, Jonathan Siau, Gérard Meunier, Jean-Michel Guichon, Olivier Chadebec. A Mixed Surface Volume Integral Formulation for the Modeling of High Frequency Coreless Inductors. 20th Compumag Conference on the Computation of Electromagnetic Fields, 2015, Jun 2015, Montréal, Canada. hal-01173994

HAL Id: hal-01173994

<https://hal.science/hal-01173994v1>

Submitted on 11 Oct 2022

HAL is a multi-disciplinary open access archive for the deposit and dissemination of scientific research documents, whether they are published or not. The documents may come from teaching and research institutions in France or abroad, or from public or private research centers.

L'archive ouverte pluridisciplinaire **HAL**, est destinée au dépôt et à la diffusion de documents scientifiques de niveau recherche, publiés ou non, émanant des établissements d'enseignement et de recherche français ou étrangers, des laboratoires publics ou privés.

A Mixed Surface Volume Integral Formulation for the Modeling of High Frequency Coreless Inductors

Zacharie De Grève⁴, Jonathan Siau^{1,2}, Gérard Meunier^{1,3}, Jean-Michel Guichon¹ and Olivier Chadebec^{1,3}

¹University of Grenoble Alpes, G2ELAB, F-38000 Grenoble, France

²CEDRAT S.A., F-38000 Grenoble, France

³CNRS, G2ELAB, F-38000 Grenoble, France

⁴Electrical Power Engineering Unit, University of Mons, Bd Dolez, 31, B-7000 Mons, Belgium

An original integral formulation dedicated to the high frequency modeling of electromagnetic systems without magnetic materials is presented. The total current density (*i.e.* conduction plus displacement currents) is approached by facet elements so that resistive, inductive and capacitive effects are all modeled. The method avoids moreover the volumic mesh of the conductors, which is too dense at high frequencies, due to the skin and proximity effects appearing *e.g.* in wound inductors. Surface impedance boundary conditions are employed to that end. The formulation is general and suitable for non simply connected domains. It is experimentally validated on a coreless wound inductor, using an impedance analyzer.

Index Terms—Computational electromagnetics, Integral equations, Electromagnetic compatibility

I. INTRODUCTION

CURRENT progresses in power electronics are enabling the use of higher switching frequencies, up to several MHz [1]. This permits to reduce the volume and the mass of the passive components, which is critical for transportation applications. This frequency range is also used for the design of wireless power transfer systems [2] (wireless charging, transcutaneous energy transmitters, etc.). At such frequencies, parasitic capacitive effects cannot be neglected, as they may induce ElectroMagnetic Compatibility (EMC) problems, or influence the resonant frequency of a wireless power transmitter.

The Partial Element Equivalent Circuit (PEEC) method offers a framework for the modeling of such physical phenomena [3]. It is an integral method which associates an RLC circuit to a meshed geometry, and which does not require the mesh of the air. An adaptation to unstructured meshes, based on the use of facet elements, has recently been proposed [4], in magnetodynamics. However, the skin and proximity effects, which appear in the conductors at such frequencies, lead to very fine meshes. Therefore, in this paper, the formulation of [4] is extended so as to avoid the volumic mesh of the conductors. Surface Impedance Boundary Conditions (SIBCs) are employed to that end. The capacitive effects are moreover taken into account using the formalism presented in [5]. The method is described in Section II, and is experimentally validated in Section III on a coreless wound inductor.

II. FORMULATION

The magnetic vector and electric scalar potentials, \mathbf{A} and V respectively, are first expressed in their integral form:

$$\mathbf{A}(\mathbf{x}) = \frac{\mu_0}{4\pi} \left(\int_{\Omega_J} \frac{\mathbf{J}}{r} d\Omega + \int_{\Omega_D} j\omega \frac{\mathbf{P}}{r} d\Omega \right), \quad (1)$$

$$\frac{\partial V}{\partial t}(\mathbf{x}) = \frac{1}{4\pi\epsilon_0} \left(\int_{\Omega_J} \mathbf{J} \text{grad} \frac{1}{r} d\Omega + \int_{\Omega_D} j\omega \mathbf{P} \text{grad} \frac{1}{r} d\Omega \right), \quad (2)$$

in the frequency domain, with j the imaginary number, ω the angular frequency, \mathbf{J} the conduction current density, \mathbf{P} the electric polarization, μ_0 (ϵ_0) the magnetic permeability (electric permittivity) of vacuum, r the distance between the field sources and point \mathbf{x} . The integrals are defined on Ω_J (Ω_D), namely the domain containing the conductors (the dielectrics). The potentials are injected into the electric field \mathbf{E} equation:

$$\mathbf{E} + j\omega \mathbf{A} + \text{grad}V = 0 \quad (3)$$

A Galerkin procedure is then applied on eq. (3), by using the total current density \mathbf{J}_t as the problem unknown :

$$\mathbf{J}_t = \mathbf{J} + j\omega \mathbf{D} = \mathbf{J} + \epsilon j\omega \mathbf{E} = (\sigma + j\omega \epsilon) \mathbf{E}, \quad (4)$$

with \mathbf{D} the electric flux density and σ the electric conductivity. First order volume facet elements defined on $\Omega = \Omega_J \cup \Omega_D$ are employed [4], [5], which permits to translate the field equations into circuit equations supported by the dual mesh. This leads to the resolution of the following system of equations:

$$\left([R] + j\omega[L] + \frac{1}{j\omega}[P] \right) \{\mathbf{I}\} = \{\Delta V\}, \quad (5)$$

with $\{\mathbf{I}\}$ the total branch currents crossing the facets, $\{\Delta V\}$ the branch voltages, $[R]$ a sparse finite element resistance matrix, $[L]$ and $[P]$ the full inductance and capacitance matrices.

However, at high frequencies, the skin and proximity effects in the massive conductors lead to very fine meshes of Ω_J . Therefore, in this paper, the formulation (5) is extended so as to avoid the volumic mesh of the conductors. \mathbf{J}_t is approached by assuming that $\sigma = 0$ in Ω_D and $\sigma \gg \omega \epsilon$ in Ω_J :

$$\mathbf{J}_t = \underbrace{\mathbf{J}_t|_{\Omega_D}}_{=j\omega \mathbf{D}} + \underbrace{\mathbf{J}_t|_{\Gamma_J}}_{=\mathbf{J}} = \sum_{k \in \Omega_D} \mathbf{w}_k I_k + \sum_{i \in \Gamma_J} \mathbf{w}_{S,i} I_{S,i} \quad (6)$$

with Γ_J the boundary between Ω_J and Ω_D (or air), \mathbf{w}_k the facet basis functions (in $[m^{-2}]$), $\mathbf{w}_{S,i}$ the surface facet basis functions

(in $[m^{-1}]$). I_k is the total current crossing a facet k of Ω_D (in $[A]$), whereas $I_{S,i}$ is the total current crossing an edge $\Gamma_{J,i}$ of Γ_J , in $[A m^{-1}]$ (see Fig.1(a)).

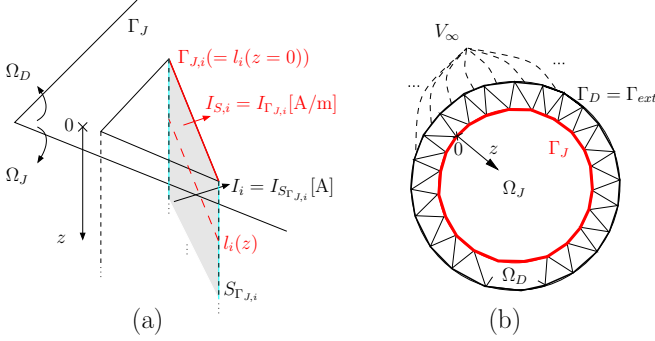


Fig. 1. (a) focus on an element of Γ_J and (b) example of discretization of a conductor with its surrounding insulation.

The total current I_i in the skin layer (*i.e.* crossing the surface $S_{\Gamma_{J,i}}$ in Ω_J) needs to be expressed as a function of the edge currents $I_{S,i}$. To that end, a first order SIBC is employed [6]:

$$I_i = \int_0^\infty I_{i(z)} dz = \int_0^\infty I_{S,i} e^{-\frac{1+j}{\delta} z} dz = \frac{\delta}{1+j} I_{S,i}, \quad (7)$$

with δ the skin depth and z the distance inside the conductor. The total current density \mathbf{J}_t (6) becomes therefore:

$$\mathbf{J}_t = \mathbf{J}_t|_{\Omega_D} + \mathbf{J}|_{\Gamma_J} = \sum_{k \in \Omega_D} \mathbf{w}_k I_k + \sum_{i \in \Gamma_J} \mathbf{w}_{S,i} \frac{1+j}{\delta} I_i \quad (8)$$

In this summary, we focus on the surface term only (*i.e.* the second sum of equation (8)), and on the corresponding modifications in the matrices of (5). To that end, equation (3) is projected on Γ_J with the $\mathbf{w}_{S,i}$:

$$\begin{aligned} & \int_{\Gamma_J} \mathbf{w}_{S,i} \frac{\mathbf{J}}{\sigma} d\Gamma + j\omega \frac{\mu_0}{4\pi} \int_{\Gamma_J} \mathbf{w}_{S,i} \left(\int_{\Omega_J} \frac{\mathbf{J}}{r} d\Omega \right) d\Gamma \\ & + j\omega \frac{\mu_0}{4\pi} \int_{\Gamma_J} \mathbf{w}_{S,i} \left(\int_{\Omega_D} \frac{\epsilon - \epsilon_0}{\epsilon} \frac{\mathbf{J}_t}{r} d\Omega \right) d\Gamma + \int_{\Gamma_J} \mathbf{w}_{S,i} \text{grad} V d\Gamma = 0 \end{aligned} \quad (9)$$

It can be shown that the last term in equation (9) corresponds to the branch voltages ΔV_i between elements of Γ_J . The volume integral on Ω_J is moreover approached by:

$$\int_{\Omega_J} \frac{\mathbf{J}}{r} d\Omega = \int_{\Gamma_J} \int_0^\infty \frac{\mathbf{J}(z=0)}{r} e^{-\frac{1+j}{\delta} z} dz d\Gamma \simeq \frac{\delta}{1+j} \int_{\Gamma_J} \frac{\mathbf{J}}{r} d\Gamma \quad (10)$$

By combining equations (8), (9) and (10), the matrices $[R]$ and $[L]$ of formulation (5) are therefore augmented with the following pure surface terms ($i, j \in \Gamma_J$):

$$R_{ij} = \int_{\Gamma_J} \frac{\mathbf{w}_{S,i} \mathbf{w}_{S,j}}{\sigma^*} d\Gamma \quad L_{ij} = \frac{\mu_0}{4\pi} \int_{\Gamma_J} \mathbf{w}_{S,i} \left(\int_{\Gamma_J} \frac{\mathbf{w}_{S,j}}{r} d\Gamma \right) d\Gamma \quad (11)$$

with $\sigma^* = \sigma\delta/(1+j)$ the equivalent conductivity. If $i \in \Gamma_J$ and $j \in \Omega_D$, the surface-volume coupling term reads:

$$L_{ij} = \frac{\mu_0}{4\pi} \int_{\Gamma_J} \mathbf{w}_{S,i} \left(\int_{\Omega_D} \frac{\epsilon - \epsilon_0}{\epsilon} \frac{\mathbf{w}_j}{r} d\Omega \right) d\Gamma \quad (12)$$

The matrix $[P]$, which is defined by adding capacitive branches between the facets belonging to the external border Γ_{ext} and an external reference node V_∞ (see Fig.1(b)), remains unchanged, compared to [5].

III. TEST CASE AND DISCUSSION

The formulation is tested on a 19-turn, 2 layer coreless wound inductor, with conductors of radius 0.1 mm surrounded by an insulating layer of 0.0215 mm, with $\epsilon_r = 2.5$. The coil-former is characterized by an $\epsilon_r = 3$. A circuit solver has been employed to solve the system (5), leading to 18735 unknowns (or independent circuit loops). This has to be compared to the 52000 unknowns of the full volumic formulation [5], which shows the interest of the proposed method.

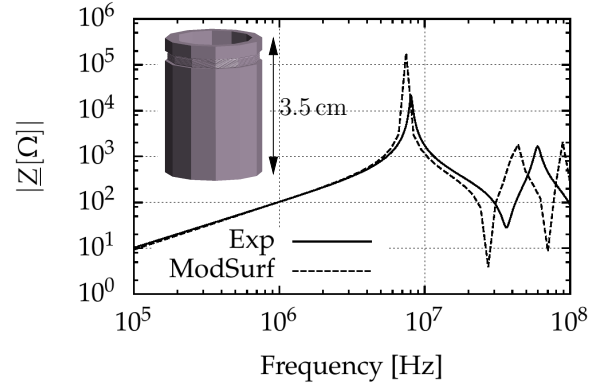


Fig. 2. Impedance of the test coil, measurement and model.

An impedance analyzer Agilent 4294A has been used to measure the impedance of the component. Figure 2 depicts the module of the impedance of the test coil, in the case of the measurement (plain lines) and the model (dotted lines). One can see that the position of the first resonance is quite similar for the two curves, which is less valid for the higher order resonances. This can be associated to uncertainties regarding the parameters of the test coil (geometry as well as material parameters). A validation on a full-wave finite element solver will be proposed in the full paper.

Moreover, the amplitude of the peaks appears to be higher with the model, which may be due to an inaccurate estimation of the coil resistance with the first order SIBC. Higher order SIBCs will be tested in the full paper.

REFERENCES

- [1] O. Deblecker, C. Versèle, Z. De Grève, "SiC vs. Si-based isolated DC-DC converters: assesment of power loss and mass gains using a multiobjective optimization tool," Int. Review of Elec. Eng., 9(4), pp.708-716, 2014.
- [2] S.Y.R. Hui, W. Zhong and C.K. Lee, "A critical review on recent progress in mid-range wireless power transfer," IEEE Trans. Power Electronics, 29(9), pp. 4500-4511, 2014.
- [3] A. Ruelhi, "Equivalent circuit models for three-dimensional multiconductor systems," IEEE Trans. Micro. th. and tech., 22(3), pp. 216-221, 1974.
- [4] T.T. Nguyen, G. Meunier, J.-M. Guichon, O. Chadebec and T.-S. Nguyen "An integral formulation for the computation of 3D eddy current using facet elements", IEEE Trans. Mag., 50(2), pp. 549-552, 2014
- [5] J. Siau, G. Meunier, O. Chadebec, J.-M. Guichon, R. Perrin-Bit, "Volume integral formulation using facet elements for electromagnetic problems considering conductors and dielectrics," Compumag 2015, submitted.
- [6] S. Yuferev, N. Ida, "Selection of the surface impedance boundary condition for a given problem," IEEE Trans. Mag., 35(3), pp.1486-1489, 1999.